

MINI-MELF-SMD

1N4454UR-1

Silicon Switching Diode

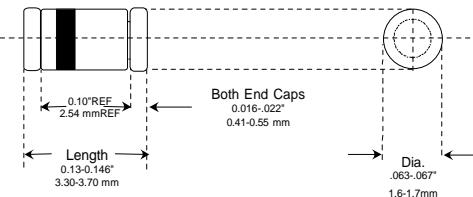
Applications

Used in general purpose applications, where performance, space and switching speed are important.

Features

- Six sigma quality
- Metallurgically bonded
- BKC's Sigma Bond™ plating for problem free solderability
- Also comes in DO-35 glass package
- Full UR approval to Mil-S-19500 /144
- Available up to JANTXV levels
- "S" level screening available to Source Control Drawings

LL-34/35 MINI MELF
Surface Mount Package DO-213AA



Maximum Ratings	Symbol	Value	Unit
Peak Inverse Voltage @ 5µA & 0.1µA @ -55°C	PIV	75 (Min.)	Volts
Average Rectified Current	I _{Avg}	200	mAmps
Continuous Forward Current	I _{Fdc}	300	mAmps
Peak Surge Current (t _{peak} = 1 sec.)	I _{peak}	1.0	Amp
Power Dissipation T _L = 50 °C, L = 3/8" from body	P _{tot}	500	mWatts
Operating Temperature Range	T _{Op}	200	° C
Storage Temperature Range	T _{St}	-65 to +200	° C
Electrical Characteristics @ 25 °C*	Symbol	Limits	Unit
Forward Voltage @ I _F = 10 mA	V _F	1.0(max)	Volts
Breakdown Voltage @ I _R = 10 mA	PIV	75 (min)	Volts
Reverse Leakage Current @ V _R = 50 V	I _R	0.1 (max)	µA
Reverse Leakage Current @ V _R = 50 V, T=150 °C	I _R	100 (max)	µA
Capacitance @ V _R = 0 V, f = 1mHz	C _T	2.0 (max)	pF
Reverse Recovery Time (note 1)/(note 2)	t _{rr}	2.0/4.0 (max)	nSecs
Forward Recovery Voltage (note 3)	V _{fr}	3.0 (max)	Volts

Note 1: Per Method 4031-A with I_F = I_R = 10 mA, R_L = 100 Ohms, C = 3 Pf.

Note 2: Per Method 4031-A with I_F = 10 mA, R_L = 100 Ohms, V_r = 6 V, Recover to 1.0 mA.

Note 3: Per Method 4026 with I_F = 100 mA, R_L = 50 Ohms, Peak Square wave ,100 nSec Pulse Width, t_r<30 nSec, repetition Rate = 5 - 100 KHz. *Unless Otherwise Specified